ASSIGNMENT RECORDATIO	4-2003	nts Only	
To do you 11 G	73847	Date: October 7, 2003 Attorney Docket No. 5649.1128	
1. Name of conveying party(ies):  (a) Se-myeong Jang (b) Gyo-young Jin (c) Yong-chul Oh (d) Hyun-chang Kim	2. Name and Samsung 416 Maet	address of receiving party(ies):  Electronics Co., Ltd. an-dong, Paldal-gu ty, Kyungki-do of Korea	
Additional name(s) of conveying party(ies) attached?Yes_x_No  3. Nature of conveyance:  x AssignmentMergerSecurity AgreementChange of NameOtherExecution Date: (a) April 1, 2003; (b) April 1, 2003; (c) 1, 2003; (d) April 1, 2003	•	OPR/FINANCE  o(s) & address(es) attached?Yes _x_No	
4. Application Serial No. 10/422,430 Patent No.  If this document is being filed together with a new application.  Additional numbers attached? Yes x No  5. Name and address of party to whom correspondence		e of the application  per of applications and patents involved:	
concerning document should be mailed:  Elizabeth A. Stanek  Myers Bigel Sibley & Sajovec  P. O. Box 37428  Raleigh NC 27627	7. Total fee (1 x Paid 4/24 Auth	7. Total fee (37 CFR 3.41) \$40.00  x Paid 4/24/2003 (see attached transmittal letter)  Authorized to be charged to deposit account  8. Deposit account number: 50-0220	
DO NOT USE THIS SPACE			
9. Statement and signature  To the best of my knowledge and belief the foregoing in	formation is true and co	want and am attached some is a two some	

Total number of pages including cover sheet, attachments and document: 3

Signature

of the original document.

Elizabeth A. Stanek Reg # 48,568

Name of Person Signing

PATENT REEL: 014572 FRAME: 0067

October 7, 2003

Date





04/25/03

PATEN'

ATENT AND TRADEMARK OFFICE

ATTY DOCKET NO.: **5649-1028** 

DATE: April 24, 2003



## UTILITY PATENT APPLICATION TRANSMITTAL LETTER AND FEE TRANSMITTAL FORM (37 CFR 1.53(b))

BOX PATENT APPLICATION Assistant Commissioner for Patents Washington, DC 20231

4-24-03

	Washington, DC 20231
	Sir:
	Transmitted herewith for filing under 37 CFR 1.53(b) is:  ☐ a patent application ☐ a Continuation ☐ a Divisional ☐ a Continuation-in-Part (CIP) Application of prior application no.:
	Inventor(s) or Application Identifier:  Se-myeong Jang; Gyo-young Jin; Yong-chul Oh; and Hyun-chang Kim
	Entitled: METHODS OF FABRICATING INTEGRATED CIRCUIT DEVICES HAVING UNIFORM SILICIDE JUNCTIONS AND INTEGRATED CIRCUIT DEVICES FABRICATED THEREBY
i/28/2003 BABR	Correspondence Address:
FC:8021	The PTO did not receive the following listed item(s)
	Enclosed are:
	<ol> <li>Application Transmittal Letter and Fee Transmittal Form (A duplicate is enclosed for fee processing)</li> <li>23 pages of Specification (including 61 claims)</li> <li>13 sheets of Formal Drawings (35 USC 113)</li> <li>Oath or Declaration         <ul> <li>a.  newly executed (original or copy)</li> <li>b.  copy from prior application (37 CFR 1.63(d) (for continuation/divisional) [Note Box 6 Below]</li> </ul> </li> </ol>
	<ul> <li>c. DELETION OF INVENTOR(S) (Signed statement deleting inventor(s) named in the prior application)</li> <li>5. Application Data Sheet. See 37 CFR 1.76</li> <li>6 Incorporation By Reference (useable if box 4b is checked)  The entire disclosure of the prior application, from which a copy of the oath or declaration is supplied under Box 4b, is considered as being part of the disclosure of the accompanying application and is hereby incorporated</li> </ul>
	by reference therein.  7. Microfiche Computer Program (Appendix)
	8. Assignment papers (cover sheet(s) and document(s))
	PATENT

REEL: 014572 FRAME: 0068

## ASSIGNMENT

THIS ASSIGNMENT, made by us, **Se-myeong Jang**, citizen of the Republic of Korea, residing at 961-802, Keukdong Baekdoo Apt., Gungnae-dong, Gunpo-city, Kyungki-do, Republic of Korea; **Gyo-young Jin**, citizen of the Republic of Korea, residing at 5/6, 427-3, Anyang6-dong, Manan-gu, Anyang-city, Kyungki-do, Republic of Korea; **Yong-chul Oh**, citizen of the Republic of Korea, residing at 426-702, Gunyoug Apt., Cheongmyung Maeul, Youngtong-dong, Paldal-gu, Suwon-city, Kyungki-do, Republic of Korea; and **Hyun-chang Kim**, citizen of the Republic of Korea, residing 106-806, Jugong Apt., Hwanggol Maeul, 948-4 Youngtong-dong, Paldal-gu, Suwon-city, Kyungki-do, Republic of Korea;

WITNESSETH: That,

METHODS OF FABRICATING INTEGRATED CIRCUIT DEVICES HAVING UNIFORM SILICIDE JUNCTIONS AND INTEGRATED CIRCUIT DEVICES

FABRICATED THEREBY, for which an application for United States Letters Patent has been filed or is being filed concurrently in the United States Patent and Trademark Office. We hereby authorize and request Myers Bigel Sibley & Sajovec, P.A., to insert here in parentheses (Application No. \_\_\_\_\_\_\_, filed \_\_\_\_\_\_\_) the filing date and application number of said application when known or to file this Assignment concurrently with the application, and

WHEREAS, we are the joint inventors of certain new and useful improvements in

WHEREAS, Samsung Electronics Co., Ltd., a Korean corporation having a principal place of business at 416 Maetan-dong, Paldal-gu, Suwon-City, Kyungki-do, Republic of Korea, hereinafter referred to as assignee, is desirous of acquiring the entire right, title and interest in and to said invention as described in said application, and in and to any and all Letters Patent which shall be granted therefor in the United States of America and all foreign countries;

NOW, THEREFORE, To Whom It May Concern, be it known that for good and valuable consideration, the receipt and sufficiency of which is hereby acknowledged, we have sold and by these presents do hereby sell, assign, transfer, and convey unto the said assignee, its successors and assigns, the entire right, title, and interest in and to the said invention and application, and in and to any and all continuations, continuations-in-part, or divisions thereof, and in and to any and all Letters Patent of the United States of America and all foreign countries or reissues or other forms of protection thereof which may be granted therefor or thereon, for the full end of the term for which said Letters Patent may be granted along with any term extensions thereon or therefor, together with the right to claim the priority of said application in all foreign countries in accordance with the International Convention, the same to be held and enjoyed by

PATENT REEL: 014572 FRAME: 0069 said assignee, its successors and assigns, as fully and entirely as the same would have been held and enjoyed by us if this assignment and sale had not been made.

We hereby request that said Letters Patent be issued in accordance with this assignment.

We further covenant and agree that, at the time of the execution and delivery of these presents, we possess full title to the invention and application above-mentioned, and that we have the unencumbered right and authority to make this assignment.

We further covenant and agree to promptly communicate to said assignee or its representatives any facts known to us relating to said invention, to testify in any interference or legal proceedings involving said invention, to execute any additional papers which may be requested to confirm the right of the assignee, its representatives, successors, or assigns to secure patent or similar protection for the said invention in all countries and to vest in the assignee complete title to the said invention and Letters Patent, without further compensation, but at the expense of said assignee, its successors, assigns, and other legal representatives; and we hereby instruct, and further covenant and agree to bind our heirs, legal representatives, and assigns, to sentatives.

do same, without	further compensation, but at the expense of said assignment	gnee or its repre
IN WITN of April	TESS WHEREOF, we have hereunto set our hands and , 20 <u>03</u> .	d seals on this _
	Se-myeong Jang	
	Se-myeong Jang	
	Gyo-young Jin	
	Gyo-young Jin	
	Yong-chul Oh. Yong-chul Oh	
	Yong-chul Oh	
	Hyum chang Kim	
	Hyun chang Kim  Hyun-chang Kim	
Witnessed by:		
Date:		
Date:		

15t day

RECORDED: 04/24/2003